PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tetsuya OGAWA	04/19/2010
Ayatoshi YOKOKAWA	04/19/2010

RECEIVING PARTY DATA

Name:	Honda Motor Co., Ltd	
Street Address:	1-1, Minami-Aoyama 2-chome	
City:	Mnato-ku, Tokyo	
State/Country:	JAPAN	
Postal Code:	107-8556	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12863891

CORRESPONDENCE DATA

Fax Number: (617)742-4214

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER: **TOW-315US**

NAME OF SUBMITTER: Anthony A. Laurentano

Total Attachments: 2

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> **PATENT** REEL: 024950 FRAME: 0807

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ASSIGNMENT

We/I,Tetsuya OGAWA and Ayatoshi YOKOKAWA of
c/o HONDA R&D CO., LTD., 4-1, Chuo 1-chome, Wako-shi, Saitama 351-0193, JAPAN,
in consideration of One Dollar and other valuable consideration paid to us by
HONDA MOTOR CO., LTD.
a corporation of <u>JAPAN</u> having its principal place of business at
1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo 107-8556, JAPAN, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said
HONDA MOTOR CO., LTD.
its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in
SOLID OXIDE FUEL CELL MANIFOLD AND CORRESPONDING STACK
described in an application
executed by us of even date herewith and about to be filed
☐ Serial No, filed on
in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And we agree, for ourselves and our executors and administrators, with said corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said corporation with specifications and claims in such form as shall be approved by the counsel of said corporation

And we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said corporation, its successors and assigns.

and to vest and confirm in said corporation, its successors and assigns, the legal title to all such

patents.

PATENT REEL: 024950 FRAME: 0808

Date: _____April 19, 2010 Witnesses: April 19, 2010 Witness 1 Satoshi SAWAND Date Witness 2 Hideji YAMADA April 19, 2010 Date WITNESS my hand and seal By: (yatoshi Yokokawa Ayatoshi YOKOKAWA Date: _____April 19, 2010 Witnesses: April 19, 2010 Witness 1 Satoshi SAWANO Date April 19, 2010 Date

WITNESS my hand and seal